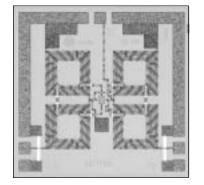


#### GaAS MMIC BI-PHASE MODULATOR 1.8 - 5.2 GHz

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#### Features

# CHIP INTEGRATES DIRECTLY INTO MIC DESIGNS The HMC135 Bi-Phase Modulator is designed 30 dB OF CARRIER SUPPRESSION DIRECT MODULATION IN THE 1.8-5.2 GHz BAND FUNCTIONS ALSO AS A PHASE DETECTOR



## General Description

to phase-modulate an RF signal into reference and 180 degree states. Device input is at the RF port and output is at the LO port. The polarity of the bias current at the control port (IF port) defines the phase states. Excellent amplitude and phase balance provided by closely matched monolithic balun and diode circuits delivers 30 dB of carrier suppression in a tiny monolithic chip.

The device also functions as a demodulator or phase comparator. As a demodulator, data emerges at the control port when a modulated signal at the RF port is compared to a reference signal at the LO port. As a phase comparator, the phase angle between two signals applied to the RF and LO ports is represented by an analog voltage at the control port.

Except for carrier suppression, the data presented here was measured under static conditions in which a DC bias current (nominally 5 mA) is applied to the control port.

# Guaranteed Performance, For 5 mA Bias Current, -55 to +85 deg C

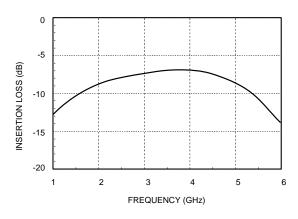
The state of the s				
Parameter	Min.	Тур.	Max.	Units
Frequency Band		1.8-5.2		GHz
Insertion Loss		9	11	dB
Return Loss, RF and LO Ports	2.5	3.0		dB
Amplitude Balance		0.2	0.5	dB
Phase Balance		2.5	5.0	deg
Carrier Suppression (When driven with a 1 MHz square wave, 1.4 Vp-p)	25	30		dBc
Input Power for 1 dB Compression	0	8		dBm
Third Order Intercept, Input	5	10		dBm
Second Order Intercept, Input	15	30		dBm
Bias Current (Bias current forward biases internal Schottky diodes providing approximately 0.6 V at the control port).	2	5	10	mA



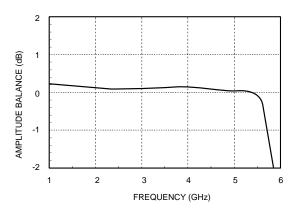
## HMC135 BI-PHASE MODULATOR 1.8 - 5.2 GHz

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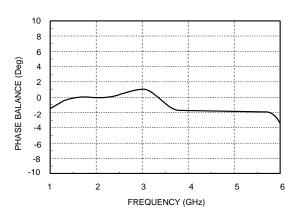
#### **Insertion Loss**



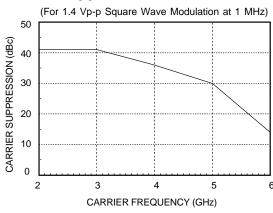
## Amplitude Balance



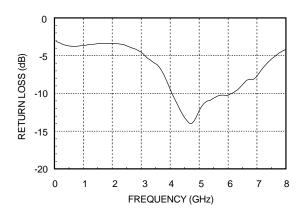
#### Phase Balance



# **Carrier Suppression**



#### Return Loss

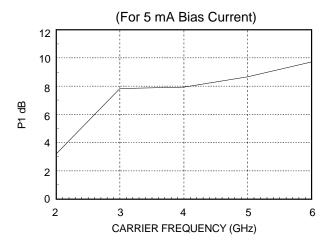




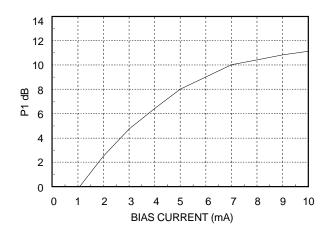
## HMC135 BI-PHASE MODULATOR 1.8 - 5.2 GHz

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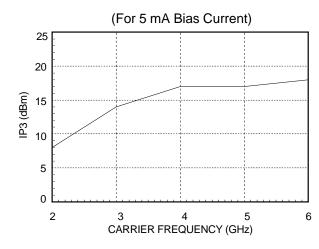
### Compression vs Frequency



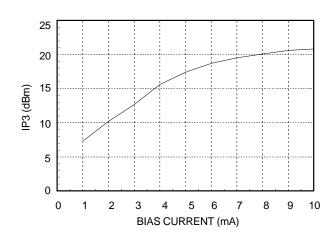
## Compression vs Bias at 4 GHz



## Third Order Intercept vs Frequency



## Third Order Intercept vs Bias at 4 GHz



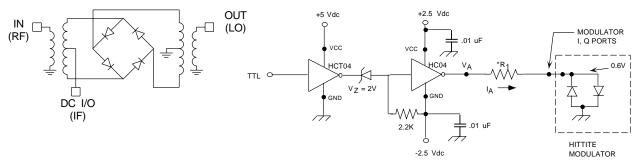


#### HMC135 BI-PHASE MODULATOR 1.8 - 5.2 GHz

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### **Schematic**

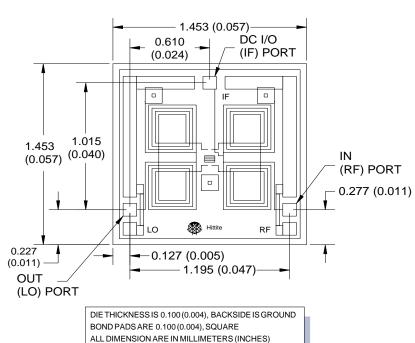
# Suggested TTL Driver for a Bi-Phase Modulator



#### **NOTES**

- 1)  $V_A$ ALTERNATESBETWEEN  $\pm 2.4 V_{dc}$   $\pm I_A = \underline{2.4 - 0.6} = \pm 5 \text{ mA}$  $360 \Omega$
- 2) HCT04 and HC04 are QMOS HEX INVERTERS.
  - $^{*}R_{_{1}} = 300\,$  TO  $620 \pm 2\%\,$  SELECT  $R_{_{1}}$  TO SUPPLY  $\pm 3\,$  TO  $\pm 6\,$  mA TO THE IF PORT

# Outline (See DIE Handling, Mounting, Bonding Note Page 8 - 3)



BOND PAD METALLIZATION: GOLD BACKSIDE METALLIZATION: GOLD ALL TOLERANCES ARE ±0.025 (0.001)